

ATTENUATOR HIGH RELIABILITY CHIP 200 MILLIWATTS

DATASHEET PART SERIES: HRMXXXXXXXXW1S

Sheet 1 of 2

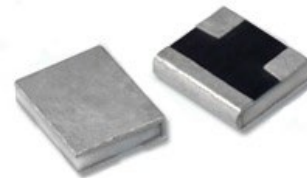
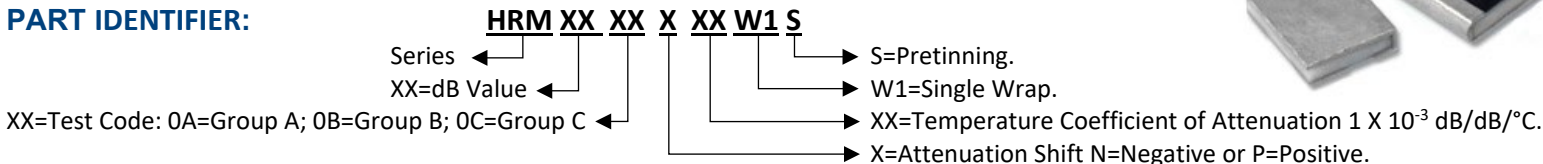
ECO-139515

Doc# HRMXXXXXXXXW1S-1009825

Revision F

ORDERING INFORMATION

PART IDENTIFIER:



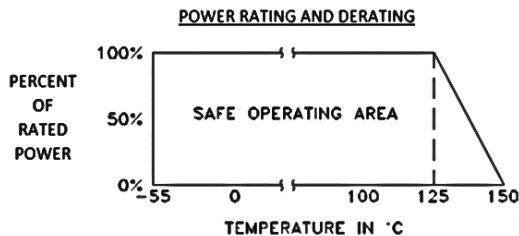
SPECIFICATION

1.0 ELECTRICAL

Nominal Impedance: 50 Ω.
 Frequency Range: DC – 12.4 GHz.
 Attenuation Values Available: See Table Below.

dB Value	DC – 12.4 GHz							
	Temperature Coefficient of Attenuation (dB/dB/°C) "Shift"							
	-0.001	-0.002	-0.003	-0.004	-0.005	-0.006	-0.007	-0.009
1dB			X	X	X	X	X	X
2dB			X	X	X	X	X	X
3dB		X	X	X	X	X	X	X
4dB			X	X	X	X	X	X
5dB			X	X	X	X	X	X
6dB			X	X	X	X	X	X
7dB			X		X		X	X
8dB			X		X		X	X
9dB			X					X
10dB	X							

Attenuation Accuracy @ 25°C: ± 0.5 dB @ 1 GHz.
 VSWR: 1.30:1 Max @ 1 GHz.
 Input Power: 200 Milliwatts Full Rated Power To 125°C, Derated Linearly to 0 Watts at 150°C.



Temperature Coefficient of Attenuation: See Table Above.
 Temperature Coefficient Tolerance: ± 0.001 dB/dB/°C.

2.0 ENVIRONMENTAL

Operating Temperature: -55°C to +150°C.

3.0 MARKING

Unit Marking: None.

4.0 QUALITY ASSURANCE

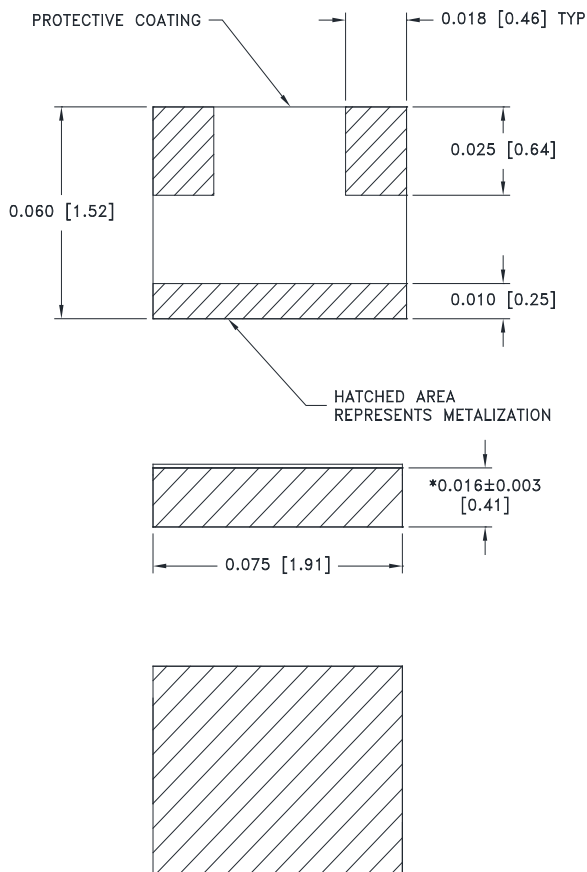
Verify 100% Visual Pre-Cap Inspection Performed Per TP-8965.
 Perform Group A, B and/or C testing as indicated by the part number per TP-8965.
 Test Data requirements:
 Test data required for customer see TP-8965.
 Data retention – 24 months.
 Test samples required for customer see TP-8965.

5.0 PACKAGING

Standard Packaging: Serialized Waffle Pack.

6.0 MECHANICAL

Substrate Material: Alumina 96%.
 Resistive Film: Thick Film.
 Terminal Material: Thick Film, Nickel Barrier, Solder Coated.
 Metric Dimensions: Provided for reference only.
 Workmanship: Per MIL-STD-130.



* DIMENSIONS APPLY BEFORE SOLDER. ALLOW 0.015 MAX FOR ALL PRETINNED SURFACES.

Unless Otherwise Specified: TOLERANCE: X.XXX = ± 0.005.